



DESCRIPTION

The SM220A~SM2200A are available in SMA package.

ORDERING INFORMATION

Package Type	Part Number
SMA	SM220A
	SM240A
	SM260A
	SM280A
	SM2100A
	SM2120A
	SM2150A
	SM2200A
Note	5,000pcs/Reel
AiT provides all RoHS Compliant Products	

FEATURES

- Metal silicon junction, majority carrier conduction
- For surface mounted applications
- Low power loss, high efficiency
- High forward surge current capability
- For use in low voltage, high frequency inverters, free wheeling, and polarity protection applications
- Available in SMA package

MECHANICAL DATA

Case: SMA

Terminals: Solderable per MIL-STD-750,
Method 2026

Approx. Weight: 60mg / 0.0021oz

PIN DESCRIPTION





ABSOLUTE MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified. Single phase, half wave, 60Hz resistive or inductive load, for capacitive load, derate by 20 %

Parameter	Symbol	SM 220A	SM 240A	SM 260A	SM 280A	SM 2100A	SM 2120A	SM 2150A	SM 2200A	Unit
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	20	40	60	80	100	120	150	200	V
Maximum RMS Voltage	V_{RMS}	14	28	42	56	70	84	105	140	V
Maximum DC Blocking Voltage	V_{DC}	20	40	60	80	100	120	150	200	V
Maximum Average Forward Rectified Current	$I_{F(AV)}$	2.0								A
Peak Forward Surge Current, 8.3ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I_{FSM}	50				40				A
Max Instantaneous Forward Voltage at 2A	V_F	0.55	0.70		0.85		0.95		V	
Maximum DC Reverse Current at Rated DC Reverse Voltage	I_R	$T_A=25^\circ C$	0.5			0.3			mA	
		$T_A=100^\circ C$	5			3				
Typical Junction Capacitance ^{NOTE1}	C_J	220	80							pF
Typical thermal Resistance ^{NOTE2}	$R_{\theta JA}$	80								°C/W
Operating Junction Temperature Range	T_J	-55 to +125								°C
Storage Temperature Range	T_{stg}	-55 to +150								°C

NOTE1: Measured at 1MHz and applied reverse voltage of 4 V D.C.

NOTE2: P.C.B. mounted with 2.0" X 2.0" (5 X 5 cm) copper pad areas.



TYPICAL PERFORMANCE CHARACTERISTICS

Figure. 1 Forward Current Derating Curve

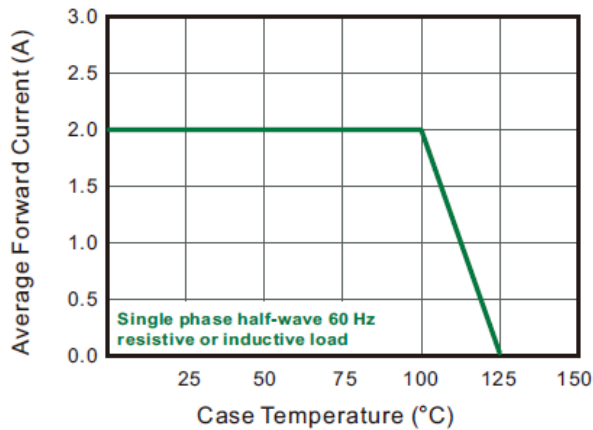


Figure. 2 Typical Reverse Characteristics

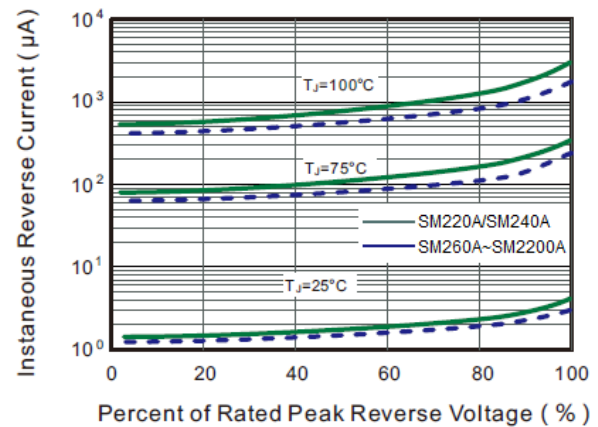


Figure. 3 Typical Forward Characteristic

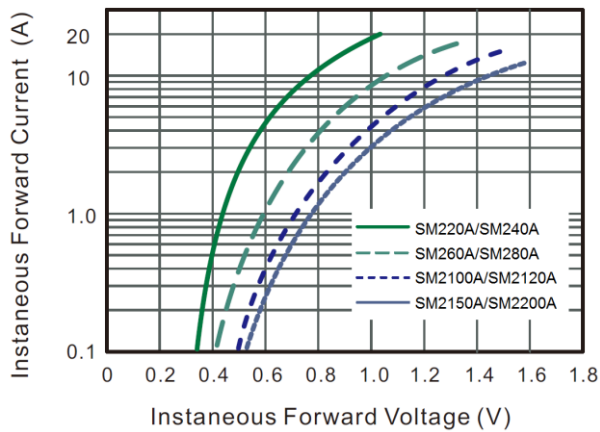


Figure. 4 Typical Junction Capacitance

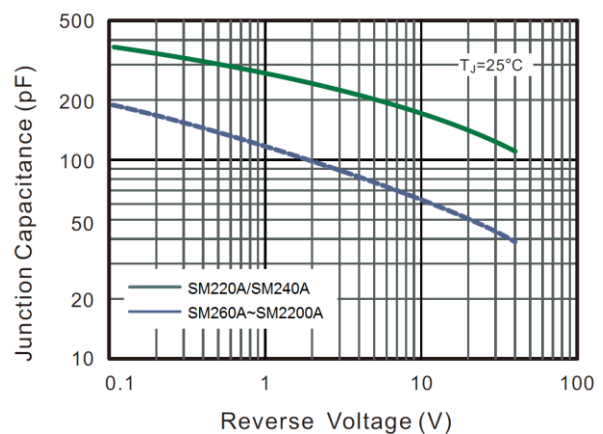


Figure. 5 Maximum Non-Repetitive Peak Forward Surge Current

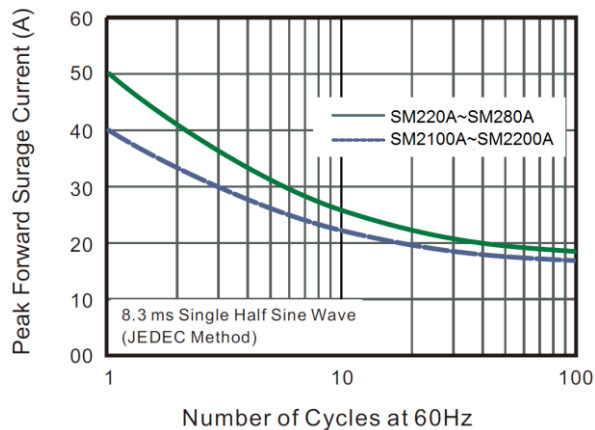
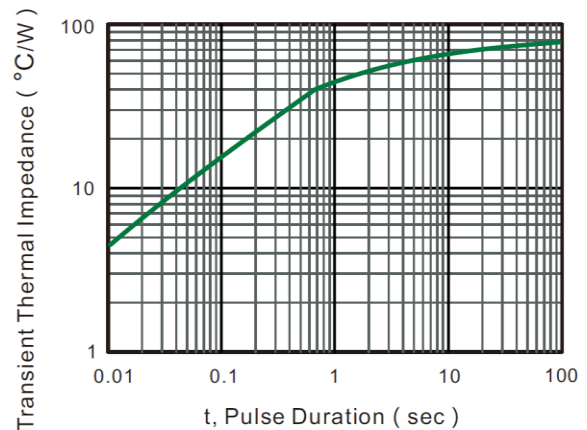


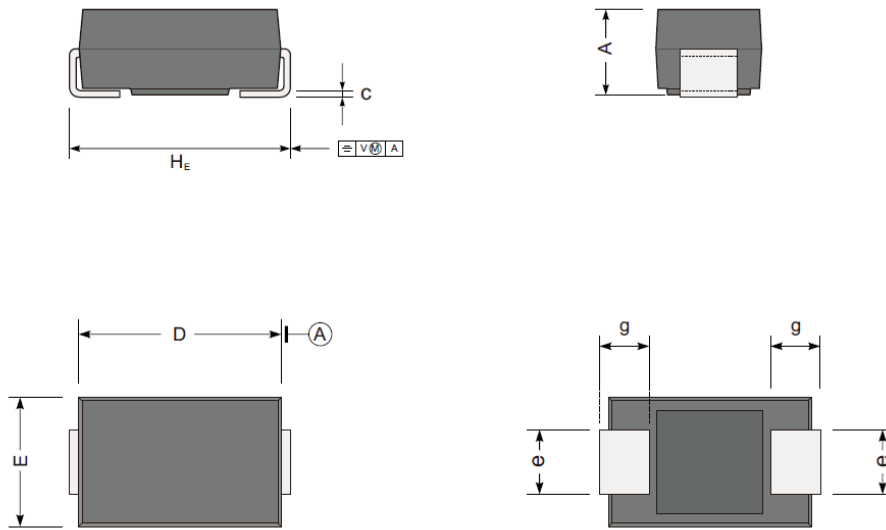
Figure. 6 Typical Transient Thermal Impedance



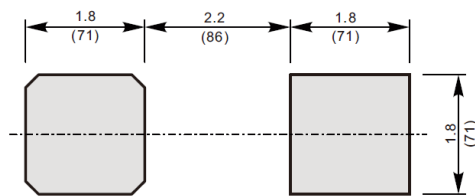


PACKAGE INFORMATION

Dimension in SMA Package (Unit: mm)



The recommended mounting pad size



Unit : $\frac{\text{mm}}{\text{(mil)}}$

UNIT		A	D	E	H_E	c	e	g
mm	max	2.2	4.83	2.9	5.4	0.31	1.7	1.5
	min	1.9	4.32	2.3	4.7	0.12	1.2	0.9
mil	max	87	190	114	213	12	67	59
	min	75	170	91	185	5	47	35



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